



N-Channel 100-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)	
100	0.0183 at V _{GS} = 10 V	60	48	
	0.023 at V _{GS} = 8.0 V	53	40	

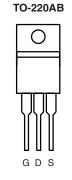
FEATURES

- TrenchFET® Power MOSFET
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC



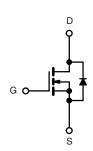
APPLICATIONS

- Industrial
- Power Supply



Top View

Ordering Information: SUP60N10-18P-E3 (Lead (Pb)-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	$T_C = 25 ^{\circ}C$, unless oth	erwise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	100	V		
Gate-Source Voltage		V _{GS}	V _{GS} ± 20		
Continuous Drain Current (T _{.I} = 175 °C)	T _C = 25 °C	1-	60		
Continuous Diain Current (1) = 175 C)	T _C = 70 °C	I _D	50	Α	
Pulsed Drain Current		I _{DM}	100		
Avalanche Current		I _{AS}	45		
Single Avalanche Energy ^a L = 0.1 mH		E _{AS}	101	mJ	
Maximum Power Dissipation ^a	T _C = 25 °C	В	150 ^b	14/	
	T _A = 25 °C ^c	P _D	3.75	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	40	°C/W	
Junction-to-Case (Drain)	R _{thJC}	1.0	C/VV	

Notes:

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.
- c. When Mounted on 1" square PCB (FR-4 material).

SUP60N10-18P

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{DS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	100			· V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.5		4.5		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 250	nA	
Zero Gate Voltage Drain Current		V _{DS} = 100 V, V _{GS} = 0 V			1	μΑ	
	I _{DSS}	V _{DS} = 100 V, V _{GS} = 0 V, T _J = 125 °C			50		
		V _{DS} = 100 V, V _{GS} = 0 V, T _J = 175 °C			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	50			Α	
Drain-Source On-State Resistance ^a		V _{GS} = 10 V, I _D = 15 A		0.015	0.0183	Ω	
	R _{DS(on)}	V _{GS} = 10 V, I _D = 15 A, T _J = 125 °C		0.027	0.033		
		V _{GS} = 8.0 V, I _D = 10 A		0.018	0.023		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		33		S	
Dynamic ^b							
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 50 V, f = 1 MHz		2600		pF	
Output Capacitance	C _{oss}			230			
Reverse Transfer Capacitance	C _{rss}			80			
Total Gate Charge ^c	Q_g			48	75	nC	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 50 \text{ A}$		16			
Gate-Drain Charge ^c	Q_{gd}			13			
Gate Resistance	R_g	f = 1 MHz	0.25	1.1	2.4	Ω	
Turn-On Delay Time ^c	t _{d(on)}			12	20		
Rise Time ^c	t _r	V_{DD} = 50 V, R_L = 1.0 Ω $I_D \cong$ 50 A, V_{GEN} = 10 V, R_g = 1 Ω		10	20	ns	
Turn-Off Delay Time ^c	t _{d(off)}			18	35		
Fall Time ^c	t _f			8	15		
Drain-Source Body Diode Character	istics T _C = 25	${}_{\circ}C_{p}$					
Continuous Current	I _S				60	Τ.	
Pulsed Current	I _{SM}				100	A	
Forward Voltage ^a	V_{SD}	I _F = 15 A, V _{GS} = 0 V		0.85	1.5	V	
Reverse Recovery Time	t _{rr}			80	120	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 50 A, dl/dt = 100 A/μs		4		Α	
Reverse Recovery Charge	Q _{rr}			160	240	nC	

Notes:

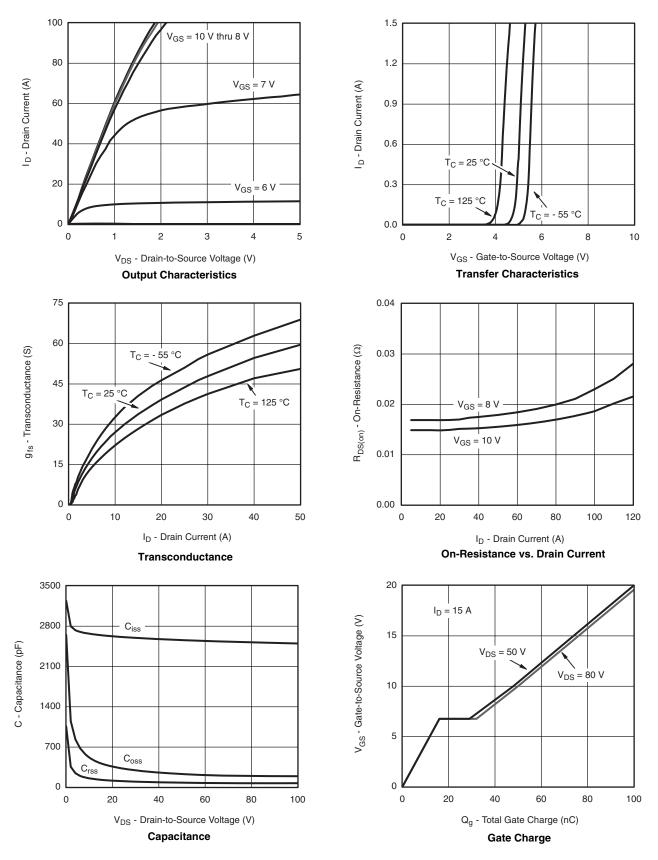
- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





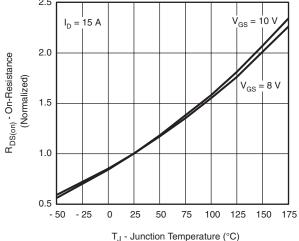
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

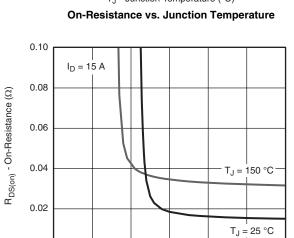


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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





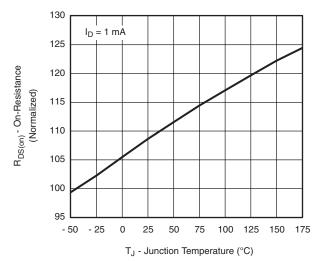
V_{GS} - Gate-to-Source Voltage (V)

On-Resistance vs. Gate-to-Source Voltage

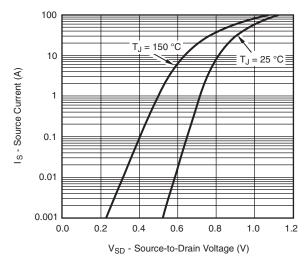
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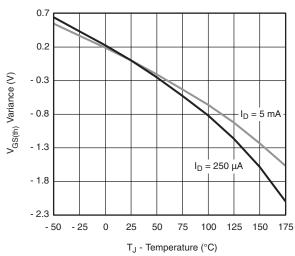
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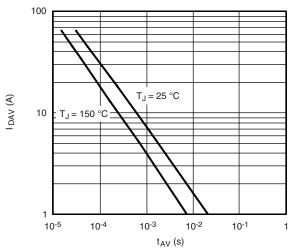
On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage



Threshold Voltage



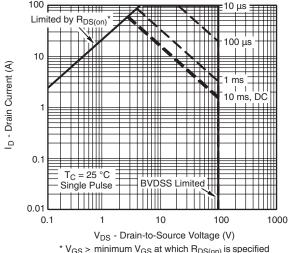
Avalanche Current vs. Time

0.00

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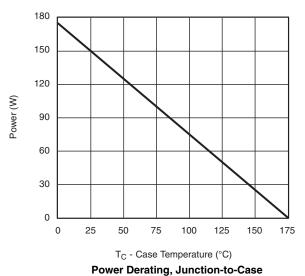


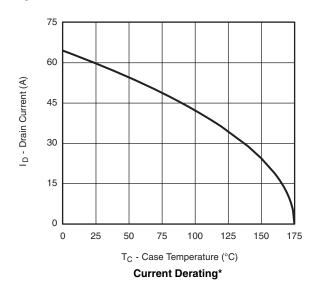
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* $V_{GS} > \mbox{ minimum } V_{GS}$ at which $R_{DS(on)}$ is specified

Safe Operating Area



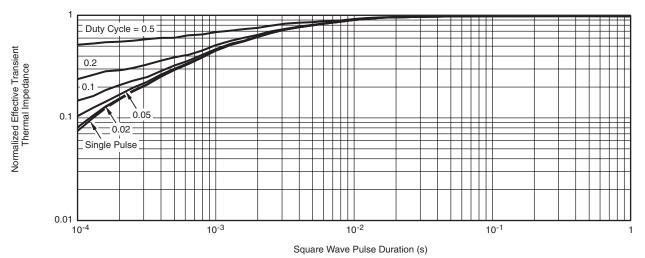


 $^{^{\}star}$ The power dissipation P_D is based on $T_{J(max.)}$ = 175 $^{\circ}$ C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?65003.



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